

# **HVU187**

# Silicon Epitaxial Planar Pin Diode for High Frequency Attenuator

REJ03G0117-0500Z (Previous: ADE-208-054D) Rev.5.00 Oct.08.2003

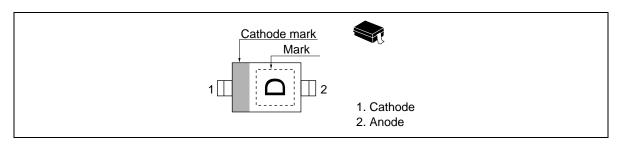
#### **Features**

- Low forward resistance. ( $r_r = 5.5 \Omega \text{ max}$ )
- Ultra small Resin Package (URP) is suitable for surface mount design.

#### **Ordering Information**

Type No.	Laser Mark	Package Code
HVU187	D	URP

## Pin Arrangement



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit	
Reverse voltage	$V_R$	60	V	
Forward current	I <sub>F</sub>	50	mA	
Power dissipation	Pd	100	mW	
Junction temperature	Tj	125	°C	
Storage temperature	Tstg	-55 to +125	°C	

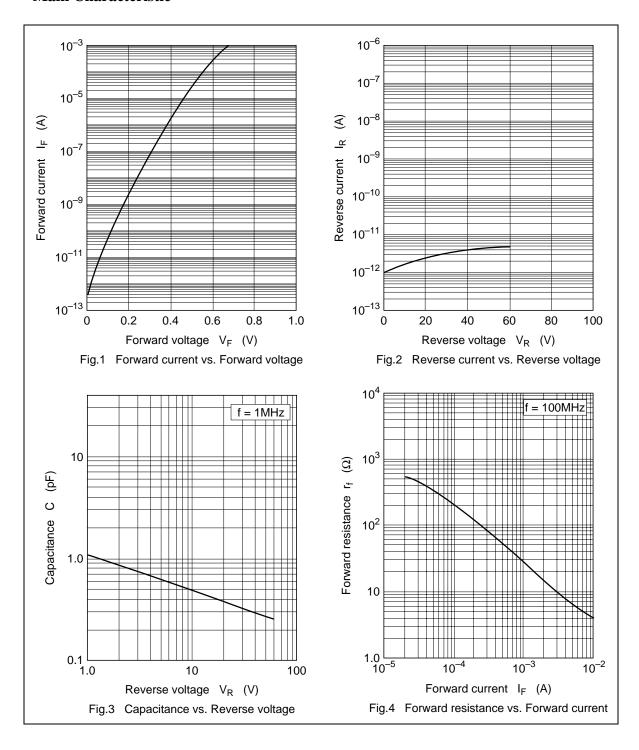
#### **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

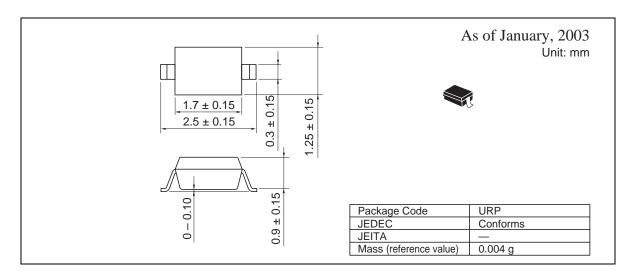
Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R</sub>	_	_	100	nA	V <sub>R</sub> = 60 V
Forward voltage	V <sub>F</sub>	_	_	1.0	V	I <sub>F</sub> = 10 mA
Capacitance	С	_	_	2.4	pF	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$
Forward resistance	r <sub>f</sub>	3.5	_	5.5	Ω	I <sub>F</sub> = 10 mA, f = 100 MHz
ESD-Capability *1	_	200	_	_	V	C = 200 pF, Both forward and reverse direction 1 pulse.

Note: 1. Failure criterion;  $I_R \ge 100 \text{ nA}$  at  $V_R = 60 \text{ V}$ 

#### **Main Characteristic**



## **Package Dimensions**



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